

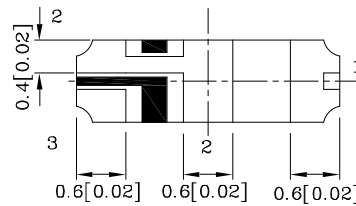
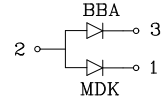
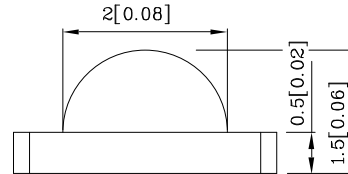
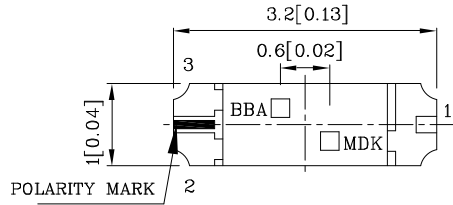
PRELIMINARY SPEC

Features

- 3.2mmx1.0mm RIGHT ANGLE SMT LED, 1.5mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- PACKAGE : 2000PCS / REEL.
- MOISTURE SENSIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES



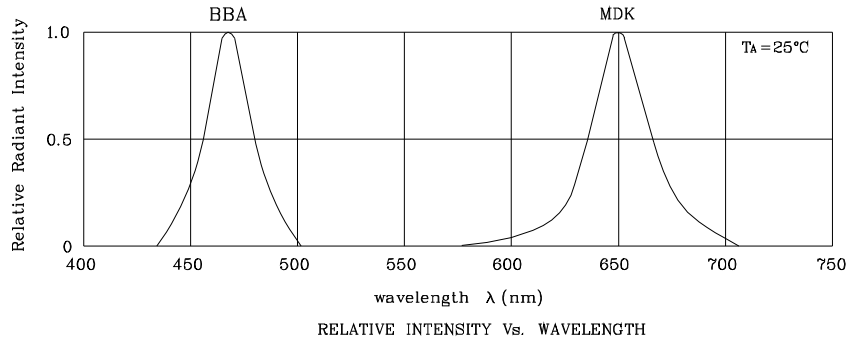
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.1(0.004)$ unless otherwise noted.
3. Specifications are subject to change without notice.

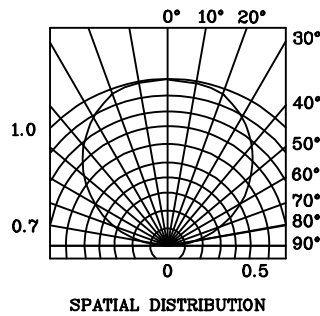
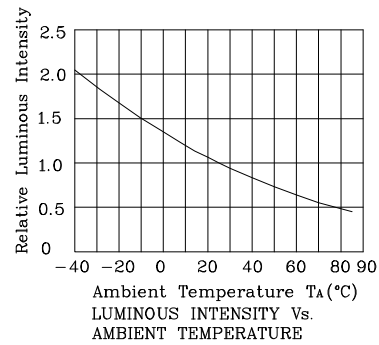
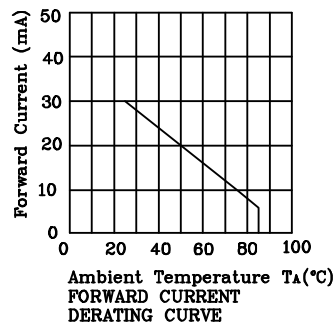
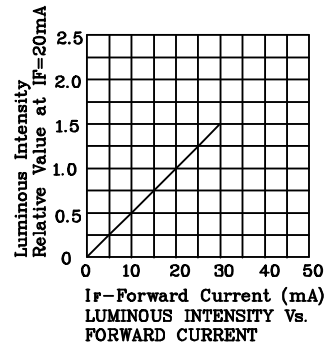
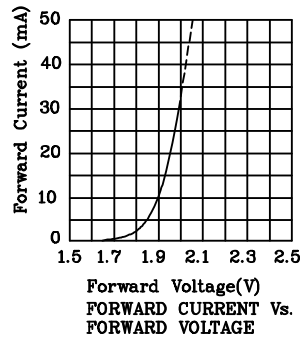
Absolute Maximum Ratings ($T_A=25^\circ\text{C}$)		MDK (InGaA IP)	BBA (InGaN)	Unit
Reverse Voltage	V_R	5	5	V
Forward Current	I_F	30	30	mA
Forward Current (Peak) 1/10Duty Cycle 0.1ms Pulse Width	i_{FS}	185	100	mA
Power Dissipation	P_T	75	120	mW
Electrostatic Discharge Threshold (HBM)		-	1000	V
Operating Temperature	T_A	-40 ~ +85		°C
Storage Temperature	T_{stg}	-40 ~ +85		

Operating Characteristics ($T_A=25^\circ\text{C}$)		MDK (InGaA IP)	BBA (InGaN)	Unit
Forward Voltage (Typ.) ($I_F=20\text{mA}$)	V_F	1.95	3.2	V
Forward Voltage (Max.) ($I_F=20\text{mA}$)	V_F	2.5	4.0	V
Reverse Current (Max.) ($V_R=5\text{V}$)	I_R	10	10	μA
Wavelength Of Peak Emission (Typ.) ($I_F=20\text{mA}$)	λ_P	650	468	nm
Wavelength Of Dominant Emission (Typ.) ($I_F=20\text{mA}$)	λ_D	635	470	nm
Spectral Line Full Width At Half-Maximum (Typ.) ($I_F=20\text{mA}$)	$\Delta\lambda$	28	21	nm
Capacitance (Typ.) ($V_F=0\text{V}$, $f=1\text{MHz}$)	C	35	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity ($I_F=20\text{mA}$) mcd		Wavelength nm λ_P	Viewing Angle 2θ 1/2
				min.	typ.		
XZMDKBBA88W	Red	InGaAlP	Water Clear	110	198	650	120°
	Blue	InGaN		18	59		

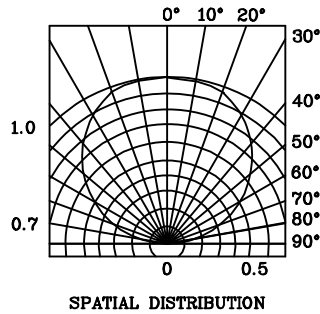
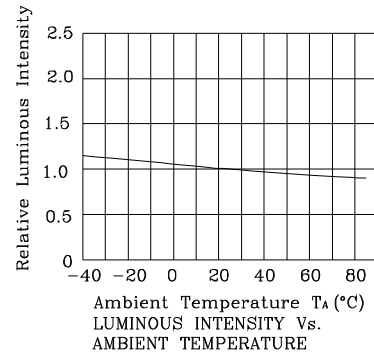
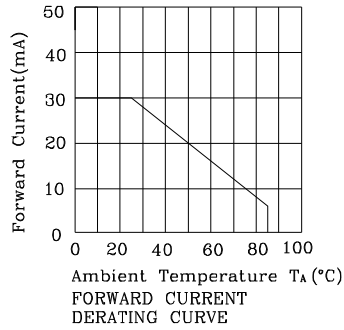
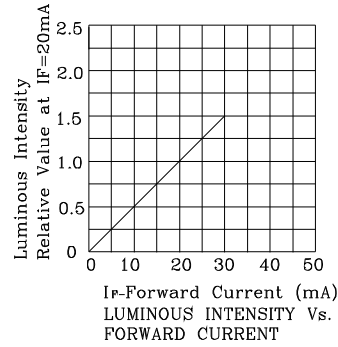
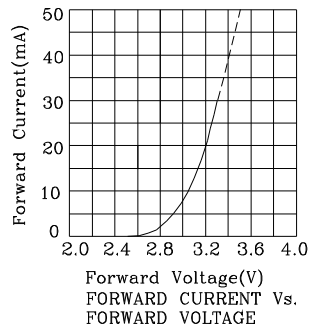


❖ MDK

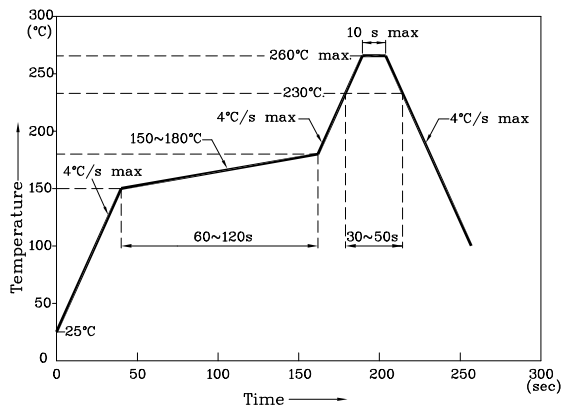




❖ BBA



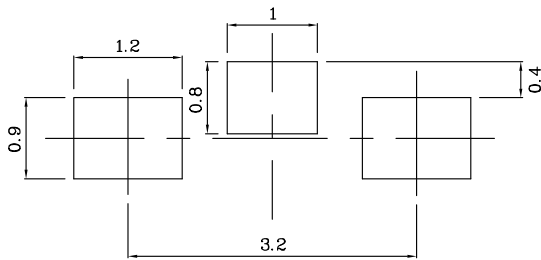
Reflow Soldering Profile For Lead-free SMT Process.



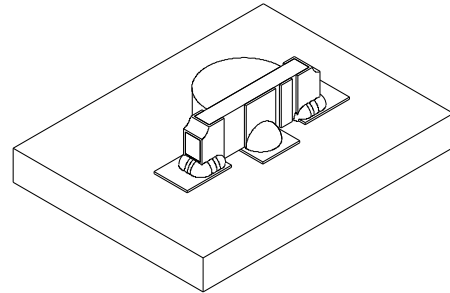
NOTES:

1. Maximum soldering temperature should not exceed 260°C.
2. Recommended reflow temperature: 145°C-260°C.
3. Do not put stress to the epoxy resin during high temperatures conditions.

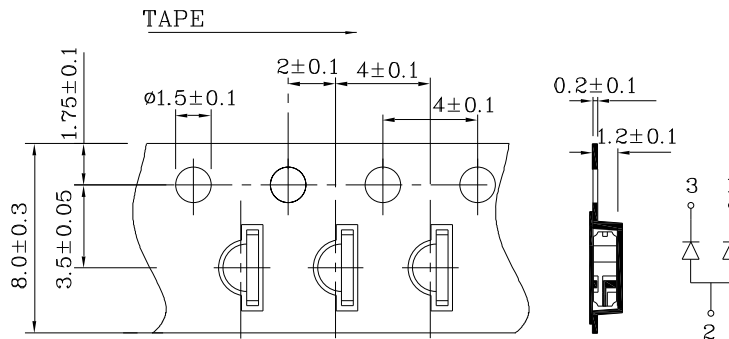
❖ Recommended Soldering Pattern (Units : mm; Tolerance: ±0.1)



❖ The device has a single mounting surface. The device must be mounted according to the specifications.



❖ Tape Specification (Units : mm)



Remarks:

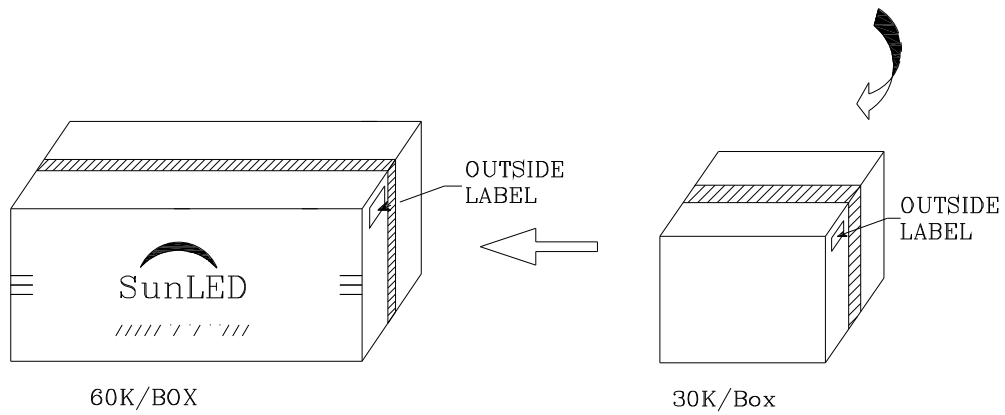
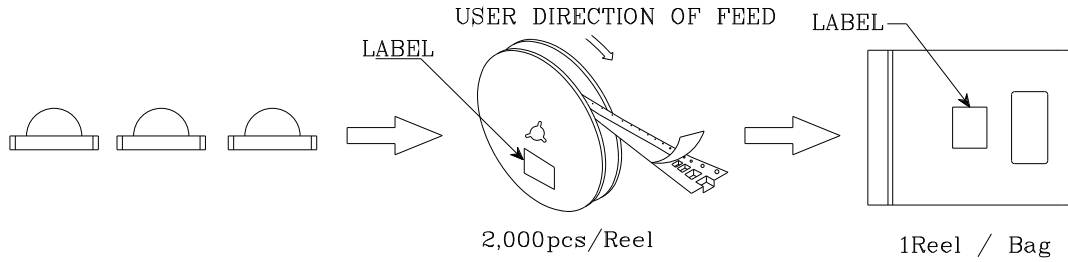

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

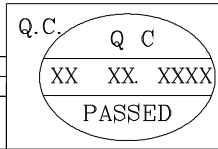

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS

XZMDKBBA88W

	
P/NO : XZxxx88x	
QTY : 2,000 pcs	CODE: XXX
S/N : XX	
LOT NO:	
 XXXXXXXXXXXXXXXXXXXXX	
RoHS Compliant	